

2811



TRANSMITTAL OF FORMAL DRAWINGS

Docket No.
FIS920010103US1

In Re Application Of: DAVES ET AL.

| Serial No. | Filing Date | Batch No. | Examiner | Art Unit |
|------------|-------------|-----------|----------|----------|
| 09/989,666 | 11/20/2001 | NYA | NYA | 2811 |

Invention: **STRUCTURE AND METHOD FOR WIRING TRANSLATION BETWEEN GRIDS WITH
NON-INTEGRAL PITCH RATIOS IN CHIP CARRIER MODULES**

Address to:
Assistant Commissioner for Patents
Washington, D.C. 20231

Transmitted herewith are:

4 sheets of formal drawing(s) for this application.

Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c)
on the reverse side of the drawing.

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Signature

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Confirmation No. 1815
Customer Service No. 29371

Dated: December 17, 2001

I certify that this document and attached formal drawings
are being deposited on 12/17/2001 with the
U.S. Postal Service as first class mail under 37 C.F.R. 1.8
and addressed to the Assistant Commissioner for Patents,
Washington, D.C. 20231.

Signature of Person Mailing Correspondence

Jessica L. Walsh

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